



PH5502B2NA1-E4

Data Sheet

R08DS0038EJ0100 Rev.1.00 Oct 05, 2011

Ambient Illuminance Sensor

DESCRIPTION

The PH5502B2NA1-E4 is an ambient illuminance sensor with a photo diode and current amplifier. This product has spectral characteristics close to human eye sensitivity and outputs light current proportional to the ambient brightness.

The PH5502B2NA1-E4 can be used to improve the performance and reduce the power consumption of digital equipment such as FPD-TV sets and mobile phones, by enabling automatic brightness control and automatic switching on and off of lighting systems.

FEATURES

• Small and thin SON package 2.55 x 1.56 x 0.55 mm

• Spectral characteristics close to human eye sensitivity Peak sensitivity wavelength 555 nm TYP.

Output characteristics proportional to illuminance

• Large output light current 230 μA TYP.@100 lx (Fluorescent light)

• Low voltage operation $V_{CC} = 1.8 \text{ to } 5.5 \text{ V}$

• Pb-free

APPLICATIONS

- FPD TV sets, displays
- Mobile phones, smartphones
- Notebook PCs, tablet PCs
- DSCs, DVCs
- FA equipment
- Lighting systems, etc.

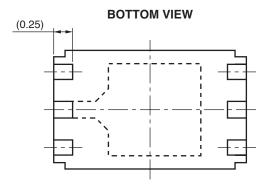
PACKAGE DIMENSIONS (UNIT: mm)

0.2

2.55±0.2 2.25 2.25 2.25 3 4 4 -

Remark Pin 1 is distinguishable by the shape of the lead frame.





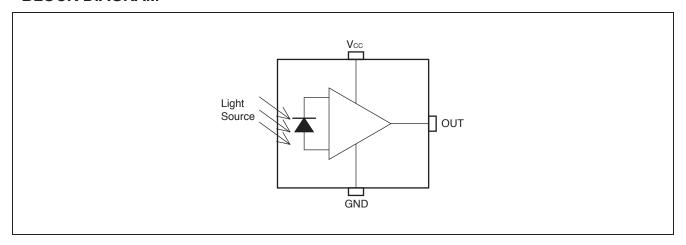
Remark () indicates nominal dimensions.

Pin No.	Terminal	
1	OUT	
2	GND	
3	V _{CC}	
4	NC	
5	NC	
6	NC	

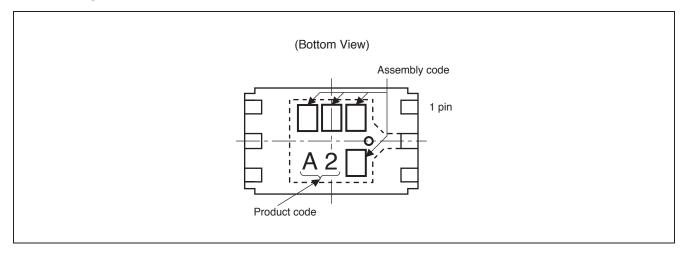
Remark 1. Connect all the NC terminals to GND or V_{CC} .

2. The bypass capacitor between $V_{\text{\footnotesize{CC}}}$ and GND is to be mounted within 20 mm of the package body.

BLOCK DIAGRAM



MARKING EXAMPLE



ABSOLUTE MAXIMUM RATINGS (T_A = 25°C, unless otherwise specified)

Parameter	Symbol	Ratings	Unit
Supply Voltage	V _{CC}	6	V
Light Current	Io	5	mA
Power Dissipation *1	P _D	135	mW
Operating Temperature	T _{opt}	-30 to +85	°C
Storage Temperature	T _{stg}	-40 to +100	°C

Note: *1. Mounted on glass epoxy board (18 mm × 13 mm × ^t0.8 mm)

RECOMMENDED OPERATING CONDITIONS

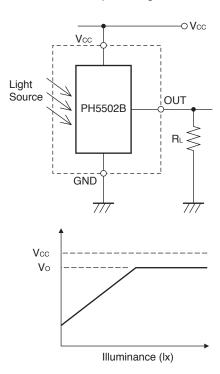
Parameter	Symbol	MIN.	TYP.	MAX.	Unit
Supply Voltage	V_{CC}	1.8	3.0	5.5	V

ELECTRO-OPTICAL CHARACTERISTICS $(T_A = 25^{\circ}C, V_{CC} = 3.0 \text{ V}, \text{ unless otherwise specified})$

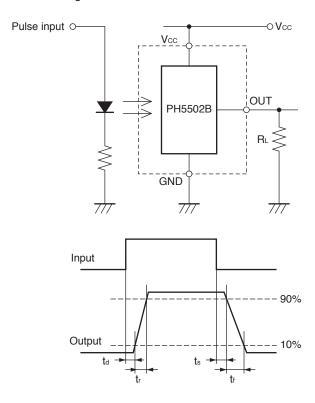
Parameter		Symbol	Conditions	MIN.	TYP.	MAX.	Unit
Supply Current	Supply Current *1		$E_V = 100 \text{ lx}^{*2}$	-	260	-	μΑ
	Peak Sensitivity Wavelength		_	-	555	-	nm
Light Current *1	Light Current *1		$E_V = 0 Ix$	-	_	0.1	μΑ
		I _{O1}	$E_V = 10 \text{ lx}^{*2}$	-	23	-	μΑ
		I _{O2}	$E_V = 100 \text{ lx}^{*3}$	-	330	-	μΑ
		I _{O3}	$E_V = 100 \text{ lx}^{*2}$	195	230	265	μΑ
Saturation Output Voltage *4		Vo	$E_V = 100 \text{ lx}, R_L = 150 \text{ k}\Omega^{*2}$	2.6	2.9	-	V
Switching	Rise Time	t _r	$R_L = 5 k\Omega^{*6}$	-	200	_	μs
Time *5	Fall Time	t _f		-	250	_	μs
	Delay Time	t _d		-	400	_	μs
	Storage Time	ts		_	10	_	μs

Note: *1 Measured under load resistance conditions of an output current unsaturated

- *2 Fluorescent light
- *3 Incandescent light
- *4 Saturation output voltage measurement method:

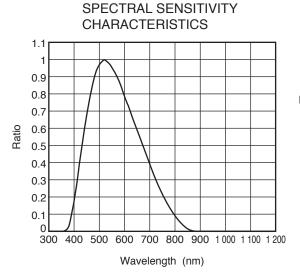


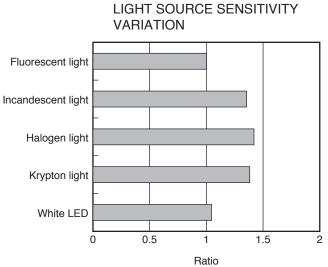
*5 Switching Time

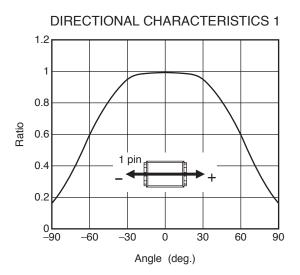


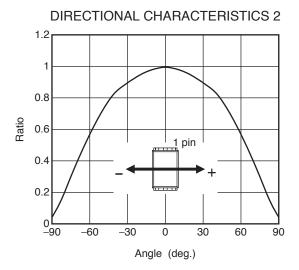
*6 White LED

TYPICAL CHARACTERISTICS ($T_A = 25$ °C, $V_{CC} = 3.0$ V, unless otherwise specified)



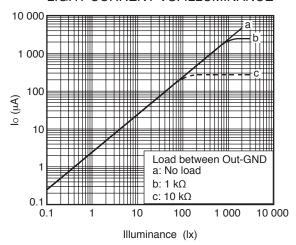




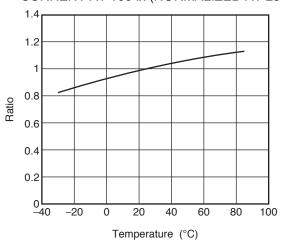


Remark The graphs indicate nominal characteristics.

LIGHT CURRENT VS. ILLUMINANCE

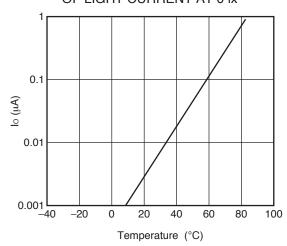


TEMPERATURE DEPENDENCY OF LIGHT CURRENT AT 100 Ix (NORMALIZED AT 25°C)

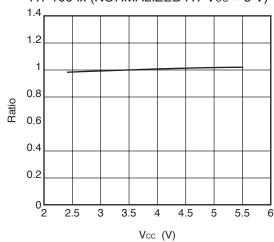


Remark The graphs indicate nominal characteristics.

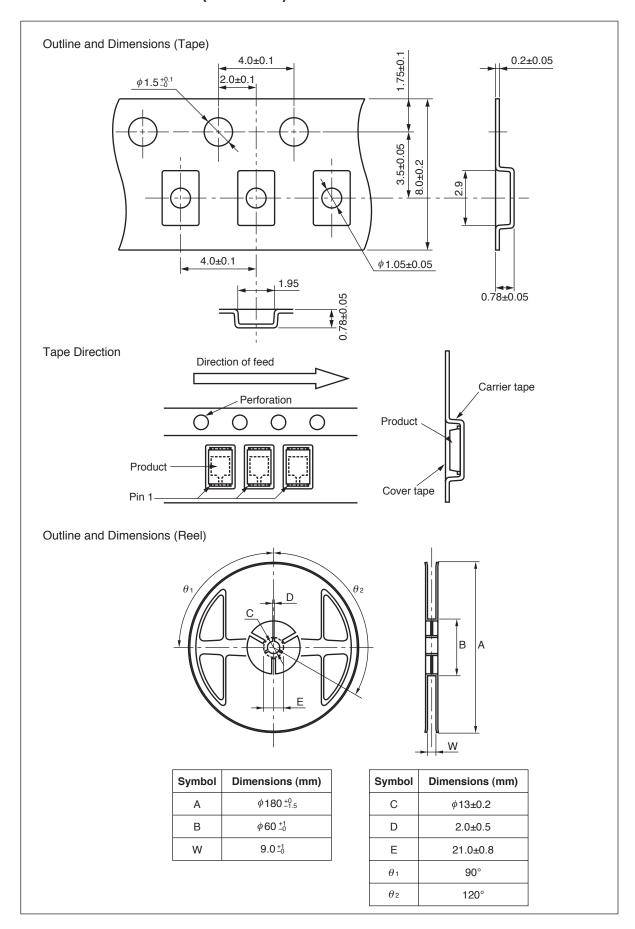
TEMPERATURE DEPENDENCY OF LIGHT CURRENT AT 0 Ix



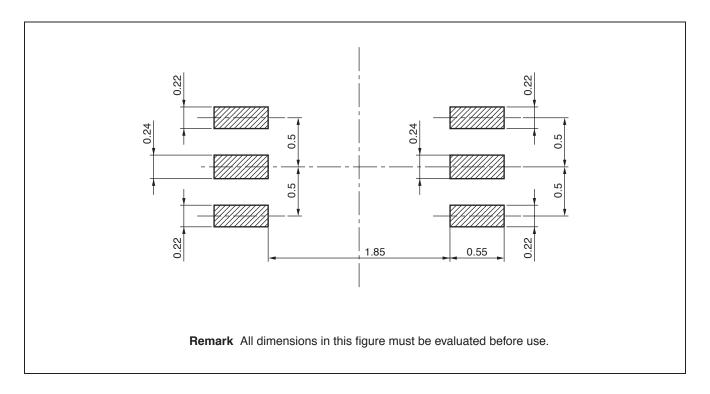
Vcc DEPENDENCY OF LIGHT CURRENT AT 100 lx (NORMALIZED AT Vcc = 3 V)



TAPING SPECIFICATIONS (UNIT: mm)



RECOMMENDED MOUNT PAD DIMENSIONS (Unit: mm)



NOTES ON HANDLING

- Recommended reflow soldering conditions
 (including infrared reflow, convection reflow, and infrared + convection reflow)
 - (1) This product is dry-packed with desiccant in order to avoid moisture absorption.
 - (2) After breaking the seal, reflow soldering must be done within 168 hours under the recommended temperature profile shown below.
 - (3) If more than 168 hours have passed after breaking the seal, the baking process must be done by using a tape and reel

Baking conditions: Once, with tape and reel, 60±5°C, 10 to 24 hours

After the baking process, this product must be stored under conditions of 30°C or below, 70% RH or below, and reflow soldering must be done within 168 hours.

<Storage conditions after breaking seal>

• Storage conditions : 30°C or below, 70% RH or below

• Maximum storage period after breaking seal : 168 hours (Second reflow soldering must be completed

within 168 hours.)

<Reflow soldering conditions>

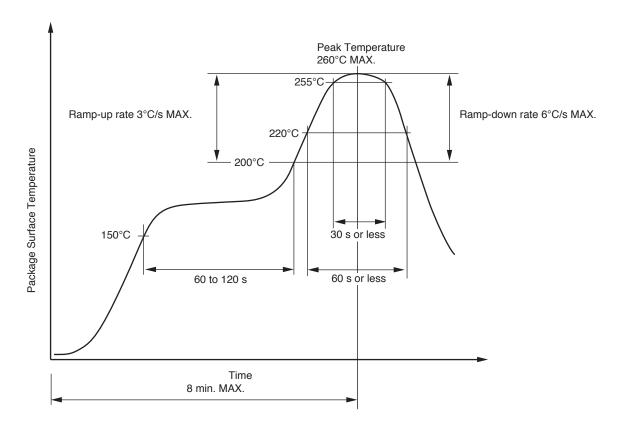
• Peak reflow temperature : 260°C or below (Package surface temperature)

• Maximum number of reflows : 2

• No repair by hand soldering

• Maximum chlorine content of rosin flux (percentage mass) : 0.2% or less

Recommended Temperature Profile of Reflow



Revision History

PH5502B2NA1-E4 Data Sheet

		Description		
Rev.	Date	Page	Summary	
1.00	Oct 05, 2011	_	First edition issued	

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